# Quad MECL-to-TTL Translator

## **Description**

The MC10H125 is a quad translator for interfacing data and control signals between the MECL section and saturated logic section of digital systems. The 10H part is a functional/pinout duplication of the standard MECL  $10K^{TM}$  family part, with 100% improvement in propagation delay, and no increase in power-supply current.

Outputs of unused translators will go to low state when their inputs are left open.

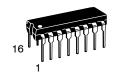
#### **Features**

- Propagation Delay, 2.5 ns Typical
- Voltage Compensated
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- MECL 10K Compatible
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



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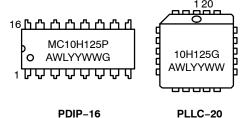
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PDIP-16 P SUFFIX CASE 648-08 PLLC-20 FN SUFFIX CASE 775-02

#### **MARKING DIAGRAMS\***



A = Assembly Location
WL. L = Wafer Lot

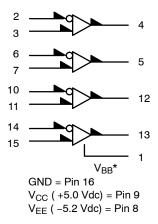
WL, L = Wafer Lot
 YY, Y = Year
 WW, W = Work Week
 G = Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping†
MC10H125FNG	PLLC-20 (Pb-Free)	46 Units / Tube
MC10H125FNR2G	PLLC-20 (Pb-Free)	500 Tape & Reel
MC10H125PG	PDIP-16 (Pb-Free)	25 Units / Tube

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>\*</sup>For additional marking information, refer to Application Note <u>AND8002/D</u>.



\*V<sub>BB</sub> to be used to supply bias to the MC10H125 only and bypassed (when used) with 0.01  $\mu$ F to 0.1  $\mu$ F capacitor to ground (0 V). V<sub>BB</sub> can source < 1.0 mA.

Figure 1. Logic Diagram

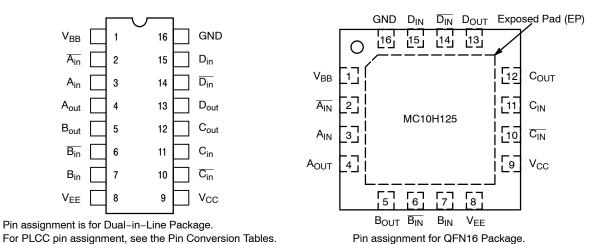


Figure 2. Pin Assignment

**Table 1. DIP CONVERSION TABLES** 

16-Pin DIL to 20-Pin PLCC																				
16 PIN DIL	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16				
20 PIN PLCC	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20				
20-Pin DIL to 20-Pin PLCC																				
20 PIN DIL	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
20 PIN PLCC	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20

**Table 2. MAXIMUM RATINGS** 

Symbol	Characteristic	Rating	Unit
V <sub>EE</sub>	Power Supply (V <sub>CC</sub> = 5.0 V)	-8.0 to 0	Vdc
V <sub>CC</sub>	Power Supply (V <sub>EE</sub> = -5.2 V)	0 to +7.0	Vdc
VI	Input Voltage (V <sub>CC</sub> = 5.0 V)	0 to V <sub>EE</sub>	Vdc
T <sub>A</sub>	Operating Temperature Range	0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range - Plastic - Ceramic	-55 to +150 -55 to +165	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 3. ELECTRICAL CHARACTERISTICS ( $V_{EE}$  = -5.2 V +5%;  $V_{CC}$  = 5.0 V + 5.0 %) (Note 2)

			)°	2	<b>5</b> °		75°	
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
Ι <sub>Ε</sub>	Negative Power Supply Drain Current	-	44	-	40	_	44	mA
I <sub>CCH</sub>	Positive Power Supply	-	63	-	63	-	63	mA
I <sub>CCL</sub>	Drain Current	-	40	-	40	-	40	mA
I <sub>inH</sub>	Input Current	-	225	-	145	-	145	μΑ
I <sub>CBO</sub>	Input Leakage Current	-	1.5	-	1.0	-	1.0	μΑ
V <sub>OH</sub>	High Output Voltage I <sub>OH</sub> = −1.0 mA	2.5	-	2.5	-	2.5	-	Vdc
V <sub>OL</sub>	Low Output Voltage I <sub>OL</sub> = +20 mA	-	0.5	-	0.5	-	0.5	Vdc
$V_{IH}$	High Input Voltage (Note 1)	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
$V_{IL}$	Low Input Voltage (Note 1)	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc
los	Short Circuit Current	60	150	60	150	50	150	mA
$V_{BB}$	Reference Voltage	-1.38	-1.27	-1.35	-1.25	-1.31	-1.19	Vdc
V <sub>CMR</sub>	Common Mode Range (Note 3)	-	-	-2.85	to +0.3			V
			Typical					
V <sub>PP</sub>	Input Sensitivity (Note 4)			1	150			mV

When V<sub>BB</sub> is used as the reference voltage.
 Each MECL 10H™ series circuit has been designed to meet the specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained.

Differential input not to exceed 1.0 Vdc.
 150 mV<sub>p-p</sub> differential input required to obtain full logic swing on output.

**Table 4. AC CHARACTERISTICS** 

		<b>0</b> °		25	5°	7		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
t <sub>pd</sub>	Propagation Delay	0.8	3.3	0.85	3.35	0.9	3.4	ns
t <sub>r</sub>	Rise Time (Note 1)	0.3	1.2	0.3	1.2	0.3	1.2	ns
t <sub>f</sub>	Fall Time (Note 1)	0.3	1.2	0.3	1.2	0.3	1.2	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Output Voltage = 1.0 V to 2.0 V.  $R_L$  = 500  $\Omega$  to GND and  $C_L$  = 25 pF to GND. Refer to Figure 1.

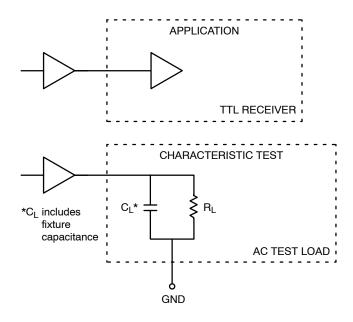


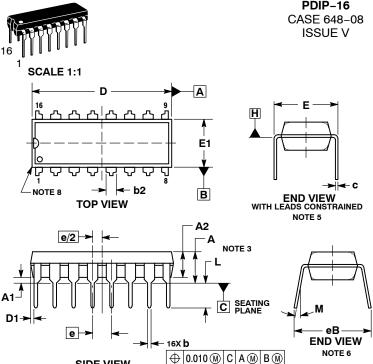
Figure 1. TTL Output Loading Used for Device Evaluation

#### **APPLICATION INFORMATION**

The MC10H125 incorporates differential inputs and Schottky TTL "totem pole" outputs. Differential inputs allow for use as an inverting/non-inverting translator or as a differential line receiver. The  $V_{BB}$  reference voltage is available on Pin 1 for use in single-ended input biasing. The outputs of the MC10H125 go to a low-logic level whenever the inputs are left floating, and a high-logic output level is achieved with a minimum input level of 150 mV<sub>p-p</sub>.

An advantage of this device is that MECL-level information can be received, via balanced twisted pair lines, in the TTL equipment. This isolates the MECL-logic from the noisy TTL environment. Power supply requirements are ground, +5.0 V and -5.2 V.

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PDIP-16

**DATE 22 APR 2015** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

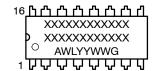
- DIMENSIONING AND TOLERANGING FER ASME 114-3M, 1994
  CONTROLLING DIMENSION: INCHES.

  DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.

  DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH
  OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE
  NOT TO EXCEED 0.10 INCH.
- DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR
- DIMENSION eB IS MEASURED AT THE LEAD TIPS WITH THE
- DIMENSION 8B IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
  DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
  PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

	INC	HES	MILLIM	ETERS	
DIM	MIN	MAX	MIN	MAX	
Α		0.210		5.33	
A1	0.015		0.38		
A2	0.115	0.195	2.92	4.95	
b	0.014	0.022	0.35	0.56	
b2	0.060	TYP	1.52 TYP		
С	0.008	0.014	0.20	0.36	
D	0.735	0.775	18.67	19.69	
D1	0.005		0.13		
E	0.300	0.325	7.62	8.26	
E1	0.240	0.280	6.10	7.11	
е	0.100 BSC		2.54	BSC	
eВ		0.430		10.92	
L	0.115	0.150	2.92	3.81	
М		10°		10°	

### **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code

= Assembly Location

WL = Wafer Lot YY = Year

WW = Work Week

G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1	:	STYLE 2	:
PIN 1.	CATHODE	PIN 1.	COMMON DRAIN
2.	CATHODE	2.	COMMON DRAIN
3.	CATHODE	3.	COMMON DRAIN
4.	CATHODE	4.	COMMON DRAIN
5.	CATHODE	5.	COMMON DRAIN
6.	CATHODE	6.	COMMON DRAIN
7.	CATHODE	7.	COMMON DRAIN
8.	CATHODE	8.	COMMON DRAIN
9.	ANODE	9.	GATE
10.	ANODE	10.	SOURCE
11.	ANODE	11.	GATE
12.	ANODE	12.	SOURCE
13.	ANODE	13.	GATE
14.	ANODE	14.	SOURCE
15.	ANODE	15.	GATE
16.	ANODE	16.	SOURCE

**SIDE VIEW** 

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## **MECHANICAL CASE OUTLINE**

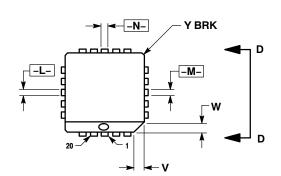


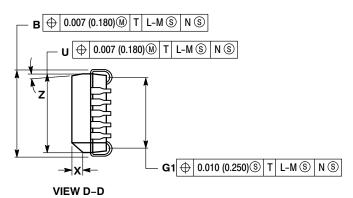


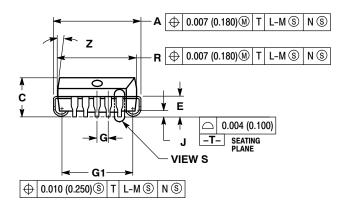
### 20 LEAD PLCC CASE 775-02 ISSUE G

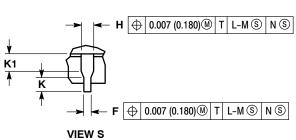
**DATE 06 APR 2021** 











#### NOTES

- DIMENSIONS AND TOLERANCING PER ANSI Y14.5M,
- 2. DIMENSIONS IN INCHES.
- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD

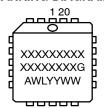
- PARTING LINE.
  DIMENSION GT, TRUE POSITION TO BE MEASURED AT DATUM -T -, SEATING PLANE.
  DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH.
  ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
  DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER
  THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300).
  DIMENSIONS R AND U ARE DETERMINED AT THE
  OUTERMOST EXTREMES OF THE PLASTIC BODY
  EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE
  BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR
  PROTRUSION OR INTRUSION. THE DAMBAR
  PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

l .	INCHES		IVIILLIIV	IEIEKO
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
С	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.021	0.33	0.53
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2°	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040		1.02	

INCHES

MILLIMETERS

#### **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code = Assembly Location

WL = Wafer Lot = Year YY WW = Work Week G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " = ", may or may not be present.

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